DSG Ansys R&D Meeting Minutes

Date: October 12, 2023 Time: 2:00 PM – 3:00 PM

<u>Attendees</u>: Aaron Brown, Peter Bonneau, Pablo Campero, Brian Eng, Tyler Lemon, and Marc McMullen

1. NPS thermal analysis with Ansys Mechanical

Aaron Brown and Pablo Campero

- 1. Ran simulation in transient mode
 - Incremented the step time to reach equilibrium of maximum temperature at the crystals
 - Allocation memory error received during the solving process; debugging in process
- 2. Created a model of
- 3. one crystal
 - Added thin slice volume attached to the rear face of the crystal to enable the setup of internal heat generation
- 4. Tested various thermal conditions
 - Heat generation of 7.5e5 W/m3
 - Heat flow of 0.3 W
- 5. Ran multiple simulations applying convection to different numbers of walls
 - Generated temperature plots
 - Noted a difference less than 0.7°C on the final maximum temperature of the crystal when model is set with internal heat generation and heat flow
 - Convection applied to different numbers of crystal external walls affects the maximum temperature of the crystal

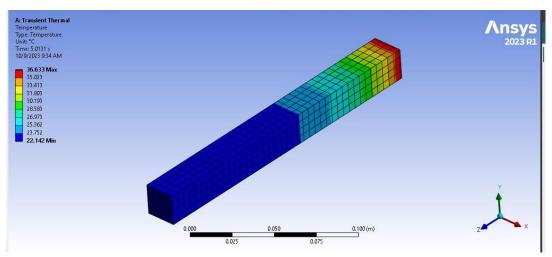


Fig. 1. Crystal with internal heat generation of 7.5e5 W/m3 and convection at 10 walls. Maximum temperature was $36.6^{\circ}C$

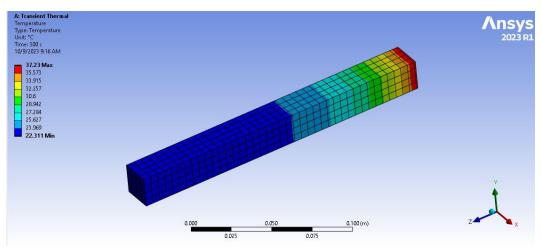


Fig. 2. Crystal with heat flow of 0.3 W and convection at 10 walls. Maximum temperature was 37.23°C

2. EIC beampipe Ansys Fluent thermal analysis

Pablo Campero

- 1. Added another layer of insulation for a total thickness of 0.78 mm
- 2. Ran thermal simulation; difference between model with 0.78-mm thickness and the model with thickness of 0.39 mm is $< 0.2^{\circ}$ C
 - Overall temperature is higher for the model with 0.78 mm
- 3. Plotted all measurements for eight airflow inlet velocities at fixed inlet flow temperature of 100°C

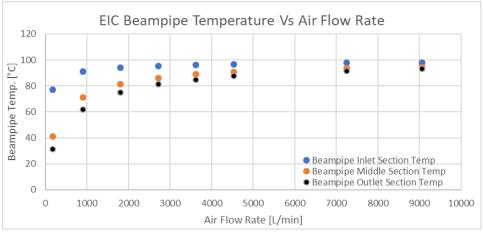


Fig.3. EIC beampipe temperature vs airflow rate